

N-channel 800 V, 3.7 Ω typ., 1.5 A MDmesh™ K5 Power MOSFET in a PowerFLAT™ 5x6 VHV package

Datasheet - production data

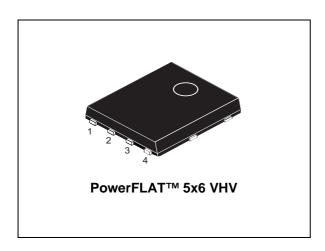
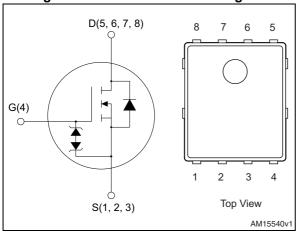


Figure 1. Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)max} .	I _D
STL2N80K5	800 V	4.5 Ω	1.5 A

- Industry's lowest R_{DS(on)}
- Industry's best figure of merit (FoM)
- Ultra low gate charge
- 100% avalanche tested
- Zener-protected

Applications

· Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in onresistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1. Device summary

Order code	Marking	Packages	Packaging
STL2N80K5	2N80K5	PowerFLAT™ 5x6 VHV	Tape and reel

Contents STL2N80K5

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STL2N80K5 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	± 30	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	1.5	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	1	Α
I _{DM} (1),(2)	Drain current (pulsed)	6	Α
P _{TOT} ⁽¹⁾	Total dissipation at T _C = 25 °C	33	W
I _{AR} ⁽³⁾	Avalanche current, repetitive or not- repetitive (pulse width limited by T _j max)	0.5	А
E _{AS} ⁽⁴⁾	$E_{AS}^{(4)}$ Single pulse avalanche energy (starting $T_i = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)		mJ
dv/dt (5)	Peak diode recovery voltage slope	4.5	V/ns
dv/dt (6)	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature	- 55 to 150	°C
T _j	Max. operating junction temperature	- 33 (0 130	°C

^{1.} The value is rated according to $\rm R_{\mbox{\scriptsize thj-case}}$ and limited by package.

- 3. Pulse width limited by T_{jmax}
- 4. Starting T_j =25 °C, I_D = I_{AR} , V_{DD} =50 V
- 5. $I_{SD} \le 1.5 \text{ A, di/dt} \le 100 \text{ A/}\mu\text{s, V}_{DS(peak)} \le V_{(BR)DSS}$
- 6. $V_{DS} \le 640 \text{ V}$

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	3.7	°C/W
R _{thj-amb} ⁽¹⁾	Thermal resistance junction-amb max	59	°C/W

1. When mounted on 1inch² FR-4 board, 2 oz Cu.

^{2.} Pulse width limited by safe operating area.

Electrical characteristics STL2N80K5

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0, I_D = 1 \text{ mA}$	800			V
1	Zero gate voltage	$V_{GS} = 0, V_{DS} = 800 \text{ V}$			1	μΑ
drain current	drain current	V _{DS} = 800 V, T _C =125 °C			50	μA
I _{GSS}	Gate-body leakage current	V _{DS} = 0, V _{GS} = ± 20 V			± 10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 100 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 1 A		3.7	4.5	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	105	-	pF
C _{oss}	Output capacitance	$V_{GS} = 0, V_{DS} = 100 \text{ V},$	-	8	-	pF
C _{rss}	Reverse transfer capacitance	f = 1 MHz	-	0.5	-	pF
C _{o(tr)} ⁽¹⁾	Equivalent capacitance time related	$V_{GS} = 0$, $V_{DS} = 0$ to 640 V	-	16	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	VGS - 0, VDS - 0 to 040 V	-	7	-	pF
R _G	Intrinsic gate resistance	f = 1 MHz, I _D =0	-	18	-	Ω
Qg	Total gate charge	V _{DD} = 640 V, I _D = 2 A,	-	5	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 10 V	-	1	-	nC
Q _{gd}	Gate-drain charge	(see Figure 16)	-	3.7	-	nC

^{1.} $C_{oss\ eq.}$ time related is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

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^{2.} $C_{oss\ eq.}$ energy related is defined as a constant equivalent capacitance giving the same stored energy as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 400 V, I _D = 1 A,	-	8	-	ns
t _r	Rise time	$R_G = 4.7 \Omega, V_{GS} = 10 V$	-	12	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 15),	-	19	-	ns
t _f	Fall time	(see <i>Figure 20</i>)	-	32	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		1.5	Α
I _{SDM}	Source-drain current (pulsed)		1		6	Α
V _{SD} ⁽¹⁾	Forward on voltage	$V_{GS} = 0, I_{SD} = 2 A$	-		1.5	V
t _{rr}	Reverse recovery time	0.0 11/14 400.0/	-	255		ns
Q _{rr}	Reverse recovery charge	I _{SD} = 2 A, di/dt = 100 A/μs V _{DD} = 60 V (see <i>Figure 17</i>)	-	1		μC
I _{RRM}	Reverse recovery current	Top of t (cost igaic ii)	-	8		Α
t _{rr}	Reverse recovery time	I _{SD} = 2 A, di/dt = 100 A/μs	-	285		ns
Q _{rr}	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 ^{\circ}\text{C}$	-	1.45		μC
I _{RRM}	Reverse recovery current	(see Figure 17)	-	7.5		Α

^{1.} Pulsed: pulse duration = $300 \mu s$, duty cycle 1.5%

Table 8. Gate-source Zener diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
V _{(BR)GSO}	Gate-source breakdown voltage	I_{GS} = ± 1mA, I_{D} =0	30	ı	1	V

The built-in back-to-back Zener diodes have specifically been designed to enhance the device's ESD capability. In this respect the Zener voltage is appropriate to achieve an efficient and cost-effective intervention to protect the device's integrity. These integrated Zener diodes thus avoid the usage of external components.

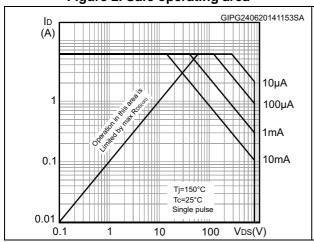


Electrical characteristics STL2N80K5

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance



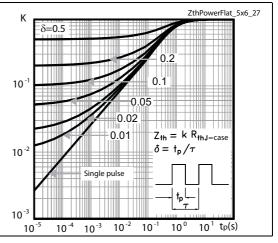
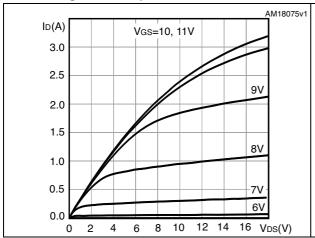


Figure 4. Output characteristics

Figure 5. Transfer characteristics



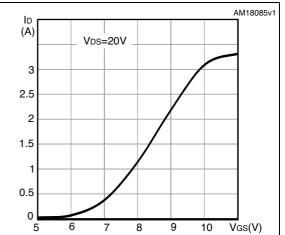
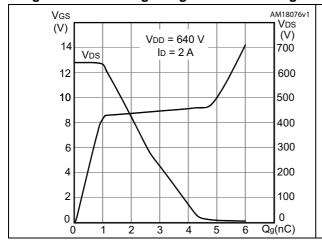


Figure 6. Gate charge vs gate-source voltage

Figure 7. Static drain-source on-resistance



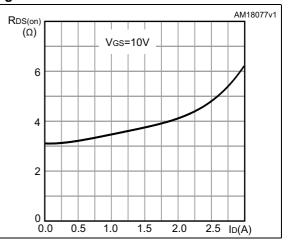
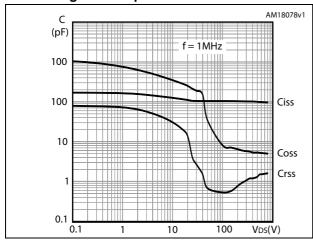


Figure 8. Capacitance variations

Figure 9. Output capacitance stored energy



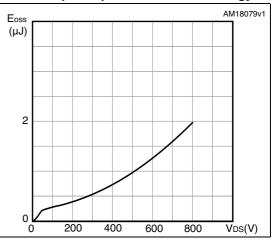
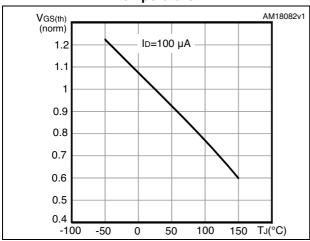


Figure 10. Normalized gate threshold voltage vs temperature

Figure 11. Normalized on-resistance vs temperature



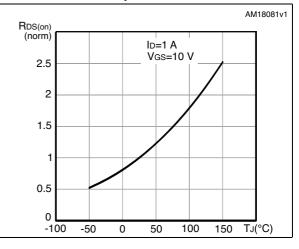
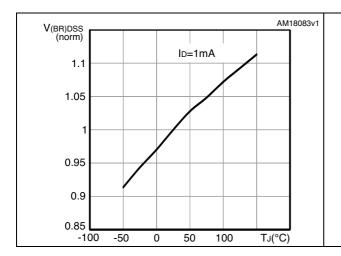
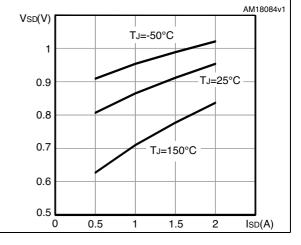


Figure 12. Normalized $V_{(BR)DSS}$ vs temperature

Figure 13. Source-drain diode forward characteristics

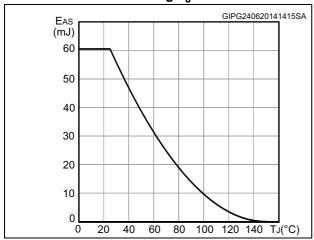




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Electrical characteristics STL2N80K5

Figure 14. Maximum avalanche energy vs starting $\mathbf{T}_{\mathbf{J}}$



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STL2N80K5 Test circuits

3 Test circuits

Figure 15. Switching times test circuit for resistive load

Figure 16. Gate charge test circuit

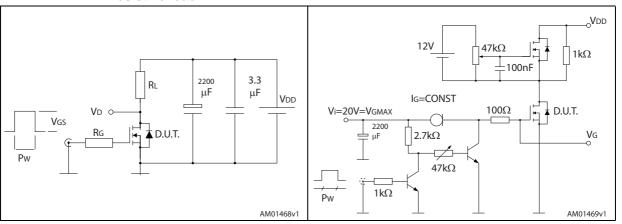


Figure 17. Test circuit for inductive load switching and diode recovery times

Figure 18. Unclamped inductive load test circuit

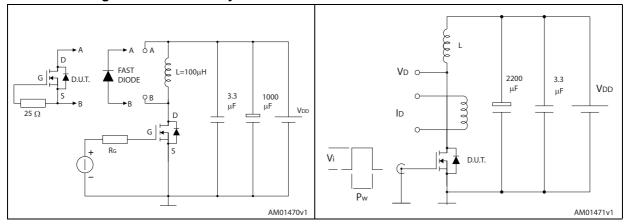
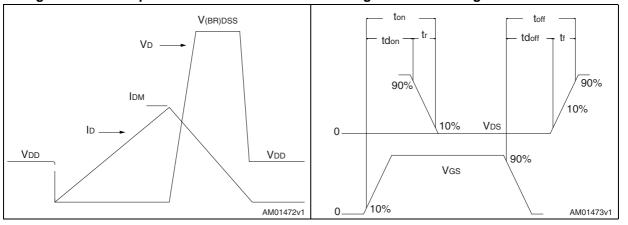


Figure 19. Unclamped inductive waveform

Figure 20. Switching time waveform





4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

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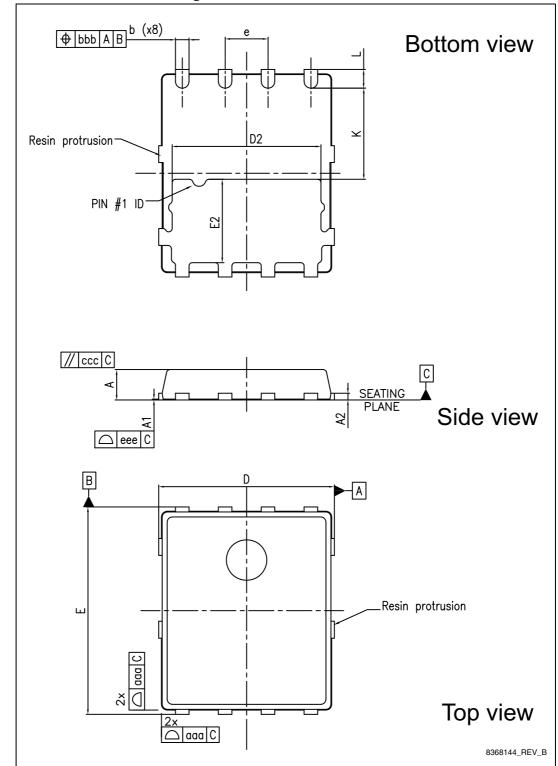


Figure 21. PowerFLAT™ 5x6 VHV

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Table 9. PowerFLAT™ 5x6 VHV mechanical data

DIM		mm.	
DIW	min.	typ.	max.
А	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
D	5.00	5.20	5.40
E	5.95	6.15	6.35
D2	4.30	4.40	4.50
E2	2.40	2.50	2.60
е		1.27	
L	0.50	0.55	0.60
К	2.60	2.70	2.80
aaa		0.15	
bbb		0.15	
ccc		0.10	
eee		0.10	

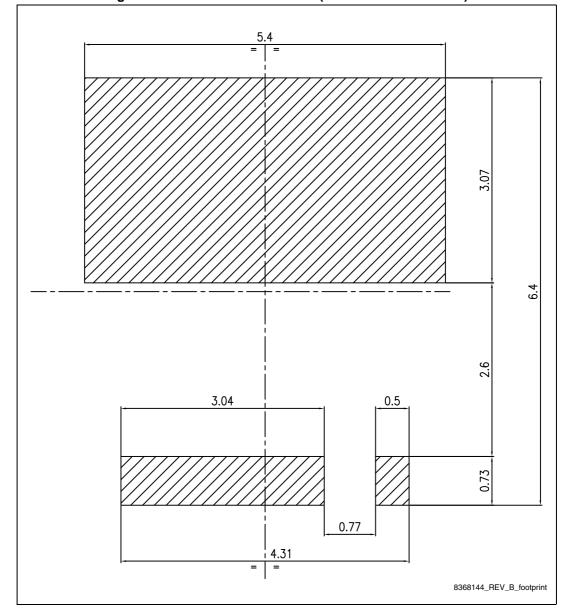


Figure 22. PowerFLAT™ 5x6 VHV (dimensions are in mm)

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5 Packaging mechanical data

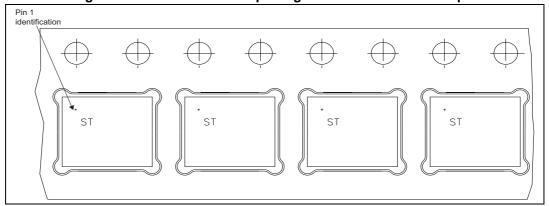
(II) Cumulative tolerance of 10 sprocket holes is $\pm\ 0.20$. (III) Measured from centerline of sprocket hole to centerline of pocket.

P₀ 4.0±0.1 (II) T (0.30±0.05) E₁ -- 1.75±0.1 Do Ø1.55±0.05 F(5.50±0.1)(III) W(12.00±0.3) P1(8.00±0.1) Ko (1.20±0.1) SECTION Y-Y (I) Measured from centerline of sprocket hole to centerline of pocket. Base and bulk quantity 3000 pcs

Figure 23. PowerFLAT™ 5x6 tape

Figure 24. PowerFLAT™ 5x6 package orientation in carrier tape.

All dimensions are in millimeters



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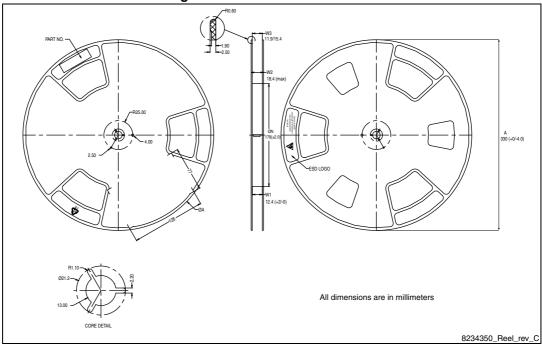


Figure 25. PowerFLAT™ 5x6 reel



Revision history STL2N80K5

6 Revision history

Table 10. Document revision history

Date	Revision	Changes
09-Aug-2013	1	First release.
24-Jul-2014	2	 Modified: title Modified: Features table Modified: I_D, I_{DM}, P_{TOT}, I_{AR}, E_{AS} values and note 5 in Table 2 Modified: R_{thj-case} value in Table 3 Modified: R_{DS(on)} values in Table 4 Modified: the entire typical values in Table 5, 6 and 7 Added: Section 2.1: Electrical characteristics (curves) Minor text changes.
25-Sep-2015	3	 Updated title in cover page. Updated Figure 6, Figure 7 and Figure 8. Minor text changes.



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